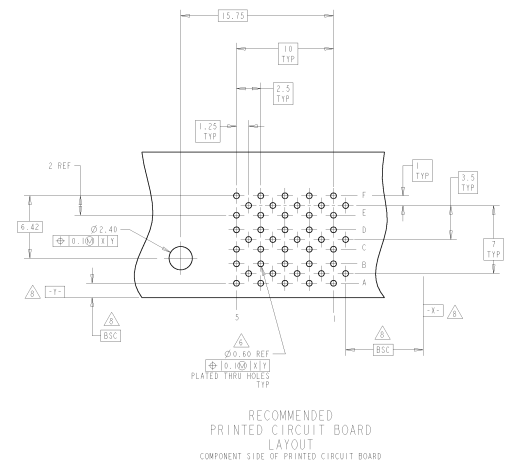
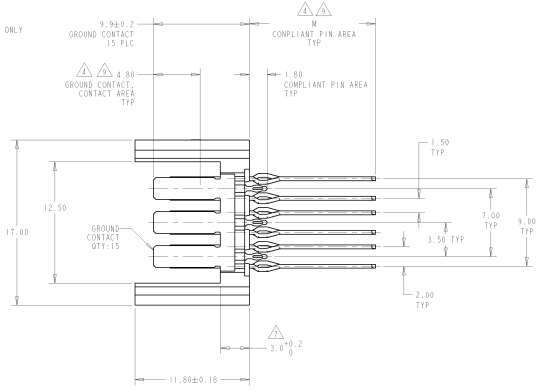
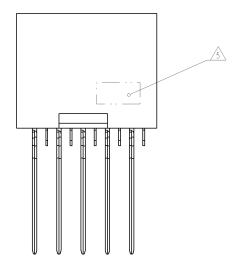
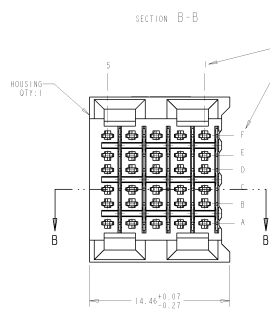
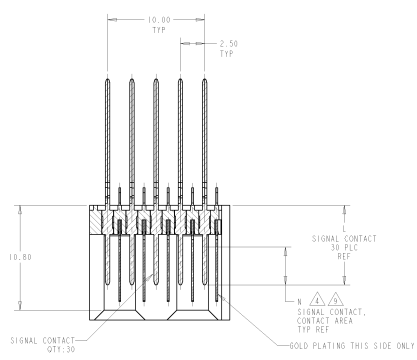


REV	DATE	DESCRIPTION	BY	CHK	APP
AD	4/7				
F		ADDED STAND-OFFS PER 0512-0157-R3	WROBNAK	SJM	DAP
G		ADDED GOLD PLATE NOTE PER 0512-0411-03	WROBNAK	SJM	DAP
G.1		REV PER ECO-06-014579	WROBNAK	DAP	DAP

- ⚠ PHOSPHOR BRONZE
- ⚠ LCP, UL94V-0
- ⚠ 0.16µm MIN GOLD OVER 1.27µm MIN NICKEL UNDERPLATE OR GOLD FLASH OVER 0.76µm MIN PALLADIUM-NICKEL OVER 1.27µm MIN NICKEL UNDERPLATE ON CONTACT AREA, 0.16µm MIN TIN LEAD OVER 1.27µm MIN NICKEL ON COMPLIANT PIN AREA
- ⚠ CONNECTOR MARKED WITH PART NUMBER AND DATE CODE
- ⚠ REFERENCE APPLICATION SPEC 114-13020 FOR RECOMMENDED PLATED THRU HOLE DIAMETER AND PLATING THICKNESSES
- ⚠ APPLICATION SEATING HEIGHT TO PRINTED CIRCUIT BOARD
- ⚠ DATINGS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER
- ⚠ CONTACT AREA LUBRICATED WITH BELLCORE APPROVED LUBRICANT TECHNICAL REFERENCE: GR-1217-CORE, ISSUE 1, NOVEMBER 1995



5.30	14.50	9.7	120680-2
3.90	13.00	8.2	120680-1
N	M	L	PART NUMBER

DATE PREPARED BY: 08/20/09 DESIGNED FOR: CUSTOMER BY: TERRY ELECTRONICS CORPORATION, 8111 WILSON ROAD	REV: 47 DATE: 4/7/09	TERRY ELECTRONICS HARRISBURG, PA 17108-1808
MATERIAL: PHOSPHOR BRONZE CONTACTS: 30	SPEC: 114-13020 REV: 1 DATE: 11/15/95	HEADER ASSEMBLY, 30 POSITION, FEED THROUGH, RIGHT HAND, 6 ROW, 2-PACK RES.
CUSTOMER DRAWING:	PART: 120680-2 REV: 1	DRAWN BY: S.J.M. CHECKED BY: D.A.P.